

## Supplementary Material

### Graphene layers on bimetallic Ni/Cu(111) surface and near surface alloys in controlled growth of graphene

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**(1) Table S1** Bader charges (e/atom) of Ni(111), Cu(111) and Ni/Cu(111) SAs and  
NASs. S2

**(2) Table S2** Bader charges (e/atom) of the graphene bottom layer, Ni(111), Cu(111)  
and Ni/Cu(111) SAs and NASs in graphene-metal systems. S3

**Table S1** Bader charges (e/atom) of Ni(111), Cu(111) and Ni/Cu(111) SAs and NASs

	*L <sub>1</sub>	L <sub>2</sub>	L <sub>3</sub>	L <sub>4</sub>	L <sub>5</sub>	L <sub>6</sub>
Ni(111)	-0.03	+0.03	0.00	0.00	+0.03	-0.03
Ni(111)-Ni-Cu	0.00	-0.01	+0.01	0.00	+0.03	-0.03
Ni(111)-Cu-Ni	-0.04	+0.06	-0.02	0.00	+0.03	-0.03
Cu(111)-Ni-Cu	0.01	-0.04	+0.03	+0.01	+0.02	-0.03
Cu(111)-Cu-Ni	-0.06	+0.06	0.00	+0.01	+0.02	-0.03
Cu(111)	-0.02	+0.02	0.00	0.00	+0.02	-0.02

\*The L<sub>n</sub> is the number of the substrate layer.

**Table S2** Bader charges (e/atom) of the graphene bottom layer and metal substrates.  $C_A$  and  $C_B$  correspond to the illustration in Fig. 4, which are indicated C atoms sitting on top of the Ni atoms (labeled as the  $C_A$ ) and sitting on hollow sites (labeled as the  $C_B$ ). The  $Ni_n$  and  $Cu_n$  represent the Ni and Cu atom at the n layer of the Ni/Cu SAs and NSAs.

Stacking		Monolayer		Bilayer			
		FCC	HCP	AB		AA	
Location		FCC	HCP	FCC	HCP	FCC	HCP
Ni(111)	$C_{A1}$	- 0.24	- 0.24	- 0.22	- 0.24	- 0.22	- 0.24
	$C_{B1}$	+0.12	+0.11	+0.10	+0.12	+0.10	+0.12
	$Ni_1$	+0.11	+0.11	+0.11	+0.12	+0.12	+0.12
	$Ni_2$	+0.01	+0.01	+0.01	+0.01	+0.02	+0.01
	$Ni_3$	0.00	0.00	0.00	0.00	0.00	0.00
Ni(111)-Cu-Ni	$C_{A1}$	- 0.21	- 0.21	- 0.25	- 0.21	- 0.24	- 0.21
	$C_{B1}$	+0.12	+0.12	+0.13	+0.12	+0.11	+0.11
	$Ni_1$	+0.06	+0.06	+0.11	+0.07	+0.11	+0.07
	$Cu_2$	+0.05	+0.05	+0.04	+0.04	+0.04	+0.04
	$Ni_3$	- 0.02	- 0.02	- 0.02	- 0.02	- 0.02	- 0.02
Cu(111)-Cu-Ni	$C_{A1}$	- 0.22	- 0.22	- 0.22	- 0.22	- 0.22	- 0.22
	$C_{B1}$	+0.06	+0.06	+0.07	+0.07	+0.07	+0.07
	$Ni_1$	+0.14	+0.14	+0.14	+0.14	+0.14	+0.14
	$Cu_2$	+0.02	+0.03	+0.02	+0.03	+0.02	+0.02
	$Cu_3$	- 0.01	0.00	0.00	0.00	0.00	0.00
Ni(111)-Ni-Cu	$C_{A1}$	- 0.17	- 0.16	- 0.17	- 0.17	- 0.18	- 0.18
	$C_{B1}$	+0.16	+0.15	+0.16	+0.16	+0.16	+0.17
	$Cu_1$	+0.02	+0.01	+0.01	+0.02	+0.02	+0.01
	$Ni_2$	- 0.01	- 0.01	0.00	- 0.01	- 0.01	0.00
	$Ni_3$	+0.01	+0.01	0.00	+0.01	+0.01	0.00
Cu(111)-Ni-Cu	$C_{A1}$	- 0.11	- 0.11	- 0.12	- 0.12	- 0.13	- 0.12
	$C_{B1}$	+0.09	+0.09	+0.10	+0.10	+0.10	+0.10
	$Cu_1$	+0.02	+0.02	+0.02	+0.03	+0.04	+0.03
	$Ni_2$	- 0.03	- 0.03	- 0.03	- 0.03	- 0.03	- 0.03

Cu(111)	Cu <sub>3</sub>	+0.02	+0.03	+0.02	+0.02	+0.02	+0.02
	C <sub>A1</sub>	-0.13	-0.11	-0.12	-0.12	-0.12	-0.11
	C <sub>B1</sub>	+0.10	+0.10	+0.10	+0.10	+0.10	+0.10
	Cu <sub>1</sub>	0.00	-0.01	0.00	0.00	0.00	0.00
	Cu <sub>2</sub>	+0.02	+0.02	+0.02	+0.02	+0.02	+0.02
	Cu <sub>3</sub>	+0.01	+0.01	+0.01	+0.01	+0.01	+0.01

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